## NSN 5962-01-175-8093



View Online at https://aerobasegroup.com/nsn/5962-01-175-8093

### Memory Microcircuit - Page 1 of 2 **Body Length:** 1.290 inches **Body Width:** Between 0.500 inches and 0.610 inches **Body Height:** 0.210 inches **Maximum Power Dissipation Rating:** 1.0 watts **Operating Tempurature Range:** +0.0/+70.0 degrees celsius Storage Tempurature Range: -55.0/+150.0 degrees celsius **End Application:** Wsd: support equipment, b-52 aircraft; ballistic missile early warning sys. (bmews); aircraft, eagle f-15 **Features Provided:** High speed and low power and high performance and high reliability **Inclosure Material:** Plastic Inclosure Configuration: Dual-in-line **Output Logic Form:** Complementary-metal oxide-semiconductor logic **Input Circuit Pattern:** 22 input **Criticality Code Justification:** Feat **Terminal Surface Treatment:** Solder Voltage Rating And Type Per Characteristic: -0.5 volts power source and 7.0 volts power source **Time Rating Per Chacteristic:** 150.00 nanoseconds propagation delay time, low to high level output and 150.00 nanoseconds propagation delay time, high to low level output Memory Device Type: Rom **Special Features:** Weapon system essential **Terminal Type And Quantity:** 24 printed circuit Shelf Life:

N/a

#### Unit Of Measure:

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### Demilitarization:

Yes - demil/mli

Fiig:

A458a0

